onsemi

Anode 1

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Schottky Rectifier 20 A, 60 V Very Low VF FSV2060L

Features

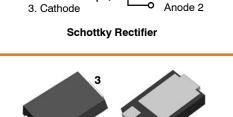
- Very Low Forward Voltage Drop
- Low Thermal Resistance
- Very Low Profile: Typical Height of 1.1 mm
- Green Molding Compound as per IEC61249 Standard
- Non–DAP Option Only
- Qualified with Reflow (J–STD–020) and Solder Temperature 260°C Classification
- Lead Free in Compliance with EU RoHS 2011/65/EU Directive
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Specifications

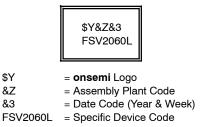
Symbol	Parameter	Value	Unit
V _{RRM}	Peak Repetitive Reverse Voltage	60	V
V _{RWM}	Working Peak Reverse Voltage	60	V
V _{RMS}	RMS Reverse Voltage	42	V
V _R	DC Blocking Voltage	60	V
I _{F(AV)}	Average Rectified Peak Forward Surge Current	20	A
I _{FSM}	Non-Repetitive Peak Forward Surge Current	320	A
TJ	Operating Junction Temperature Range	-55 to +150	°C
T _{STG}	Storage Temperature Range	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



TO-277-3LD CASE 340BQ

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

FSV2060L

Symbol	Characteristic	Minimum Land Pattern	Maximum Land Pattern	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance	100	40	°C/W
Ψ_{JL}	Junction-to-Lead Thermal Characteristics, Thermocouple Soldered to Anode	15	12	°C/W
	Junction-to-Lead Thermal Characteristics, Thermocouple Soldered to Cathode	6	5	

1. The thermal resistances ($R_{\theta JA} \& \Psi_{JL}$) are characterized with device mounted on the following FR4 printed circuit boards, as shown in Figure 1 and Figure 2. PCB size: 76.2 x 114.3 mm. Minimum land pattern size: 4.9 x 4.8 mm (big pattern, x1), 1.4 x 1.52 mm (small pattern, x2). Maximum land pattern size: 30 x 30 mm (pattern, x2). Force line trace size = 55 mils, sense line trace size = 4 mils.



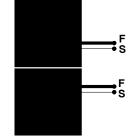


Figure 1. Minimum Land Pattern of 2 oz Copper



ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
BV _R	Breakdown Voltage	l _R = 0.5 mA	60	66	-	V
V _F	Forward Voltage Drop	I _F = 15 A	-	477	-	mV
		I _F = 20 A	-	522	600	
I _R	Reverse Current	V _R = 60 V	-	78	320	μA
CJ	Junction Capacitance	V _R = 4 V, f = 1 MHz	-	771	-	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping [†]
FSV2060L	FSV2060L	TO-277-3LD (Pb-Free/Halogen Free)	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

FSV2060L

TYPICAL PERFORMANCE CHARACTERISTICS

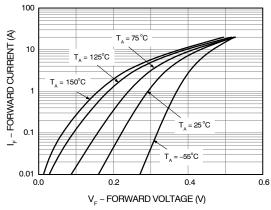


Figure 3. Typical Forward Characteristics

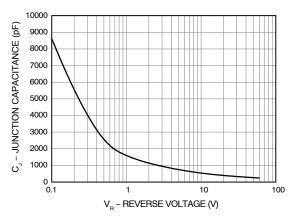


Figure 5. Typical Junction Capacitance

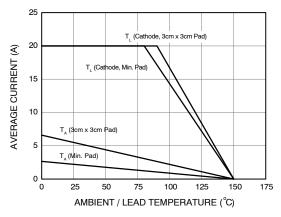


Figure 7. Forward Current Derating Curve

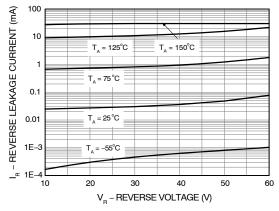


Figure 4. Typical Reverse Characteristics

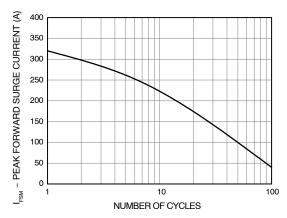


Figure 6. Maximum Non–Repetitive Peak Forward Surge Current

TO-277-3LD CASE 340BQ **ISSUE O** DATE 30 SEP 2016 6.65 6.35 6.15 В 1.40 1.10 (2X) A 5.67 4.65 MIN 1.45 MIN 4.63 4.15 MIN 4.25 1.97 0.63 0.43 (2X) 1.15 MIN **TOP VIEW** 1.00 0.01 -2.75 SEATING PLANE LAND PATTERN RECOMMENDATION 1.20 (0.35) -1.00 0.40 **FRONT VIEW** С 0.23 4.90 4.23 NOTES: UNLESS OTHERWISE SPECIFIED Ď 1.25 0.90 A. PACKAGE REFERENCE: JEDEC TO-277 **B. DIMENSIONS ARE EXCLUSIVE OF** BURRS, MOLD FLASH, AND TIE BAR 2.20 EXTRUSIONS. 4.15 3.25 2.25 \mathbf{D} 2.00 C. ALL DIMENSIONS ARE IN MILLIMETERS. 1.95 /D` DOES NOT COMPLY TO JEDEC STANDARD VALUE. **-** 0.913 (0.25)3,680 **BOTTOM VIEW** 0.60 -**DAP OPTION** 4.75 MAX 3.81

BOTTOM VIEW – DAP OPTION

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